

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Yoo, Woo Sik

Assignee: WaferMasters, Inc.

Title: Wafer Transport System and Method

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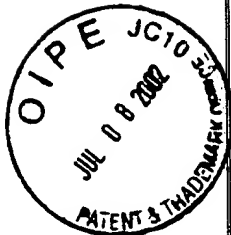
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Irvine, California
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BOX NON-FEE AMENDMENT
COMMISSIONER FOR PATENTS
Washington, D. C. 20231

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RESPONSE TO OFFICE ACTION

Dear Sir:

In response to the Office Action dated March 28, 2002, Applicants submit the following amendments and remarks.

IN THE CLAIMS

The following is a clean version of the entire set of pending claims. No Claims are amended.

1. A method for transporting semiconductor wafers comprising:
providing a processing system including a transport module and process chamber;
extending a semiconductor wafer transport device from said transport module into an
adjacently positioned container, said container being a separate component from said
processing system; and
removing at least one semiconductor wafer from said container using said wafer
transport device.

LAW OFFICES OF
MACPHERSON KWOK CHEN
& HEID LLP

2402 MICHELSON DRIVE
SUITE 210
IRVINE, CA 92612
(949) 752-7040
FAX (949) 752-7049